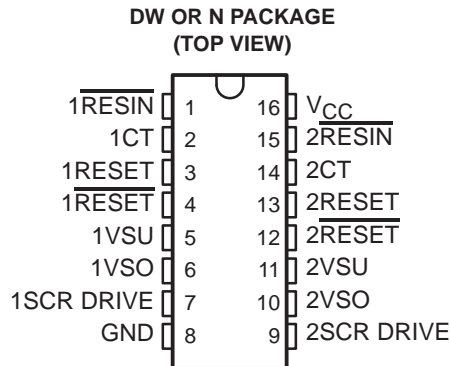# TL7770-5, TL7770-12
DUAL POWER-SUPPLY SUPERVISORS

- Power-On Reset Generator
- Automatic Reset Generation After Voltage Drop
- $\overline{\text{RESET}}$ Defined When V_{CC} Exceeds 1 V
- Wide Supply-Voltage Range . . . 3.5 V to 18 V
- Precision Overvoltage and Undervoltage Sensing
- 250-mA Peak Output Current for Driving SCR Gates
- 2-mA Active-Low SCR Gate Drive for False-Trigger Protection
- Temperature-Compensated Voltage Reference
- True and Complementary Reset Outputs
- Externally Adjustable Output Pulse Duration

DW OR N PACKAGE
(TOP VIEW)

1$\overline{\text{RESIN}}$	1	16	V_{CC}
1CT	2	15	2$\overline{\text{RESIN}}$
1RESET	3	14	2CT
1$\overline{\text{RESET}}$	4	13	2RESET
1VSU	5	12	2$\overline{\text{RESET}}$
1VSO	6	11	2VSU
1SCR DRIVE	7	10	2VSO
GND	8	9	2SCR DRIVE

description

The TL7770 is an integrated-circuit system supervisor designed for use as a reset controller in microcomputer and microprocessor power-supply systems. This device contains two independent supply-voltage supervisors that monitor the supplies for overvoltage and undervoltage conditions at the VSO and VSU terminals, respectively. When V_{CC} attains the minimum voltage of 1 V during power up, the $\overline{\text{RESET}}$ output becomes active (low). As V_{CC} approaches 3.5 V, the time-delay function activates, latching RESET and $\overline{\text{RESET}}$ active (high and low, respectively) for a time delay (t_d) after system voltages have achieved normal levels. Above V_{CC} = 3.5 V, taking $\overline{\text{RESIN}}$ low activates the time-delay function during normal system-voltage levels. To ensure that the microcomputer system has reset, the outputs remain active until the voltage at VSU exceeds the threshold value, V_{IT+}, for a time delay, which is determined by an external timing capacitor such that:

$$t_d \approx 20 \times 10^3 \times \text{capacitance}$$

where t_d is in seconds and capacitance is in farads.

The overvoltage-detection circuit is programmable for a wide range of designs. During an overvoltage condition, an internal silicon-controlled rectifier (SCR) is triggered, providing 250-mA peak instantaneous current and 25-mA continuous current to the SCR gate drive terminal, which can drive an external high-current SCR gate or an overvoltage-warning circuit.

The TL7770C series is characterized for operation from 0°C to 70°C. The TL7770I series is characterized for operation from –40°C to 85°C.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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TEXAS INSTRUMENTS

TL7770-5, TL7770-12
DUAL POWER-SUPPLY SUPERVISORS

AVAILABLE OPTIONS

| T_A | PACKAGED DEVICES | | CHIP FORM (Y) |
	SMALL OUTLINE (DW)	PLASTIC DIP (N)	
0°C to 70°C	TL7770-5CDW TL7770-12CDW	TL7770-5CN TL7770-12CN	TL7770-5Y TL7770-12Y
−40°C to 85°C	TL7770-5IDW	TL7770-5IN	—

DW package is available taped and reeled. Add the suffix R to the device type (e.g., TL7770-5CDWR). Chip forms are tested at 25°C.

functional block diagram (each channel)

| DEVICE | 1 VSU | | 2 VSU | |
	R1†	R2†	R1	R2
TL7770-5	24 kΩ	10 kΩ	Short	Open
TL7770-12	70 kΩ	10 kΩ	Short	Open

† The values listed are nominal.

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POST OFFICE BOX 655303 ● DALLAS, TEXAS 75265
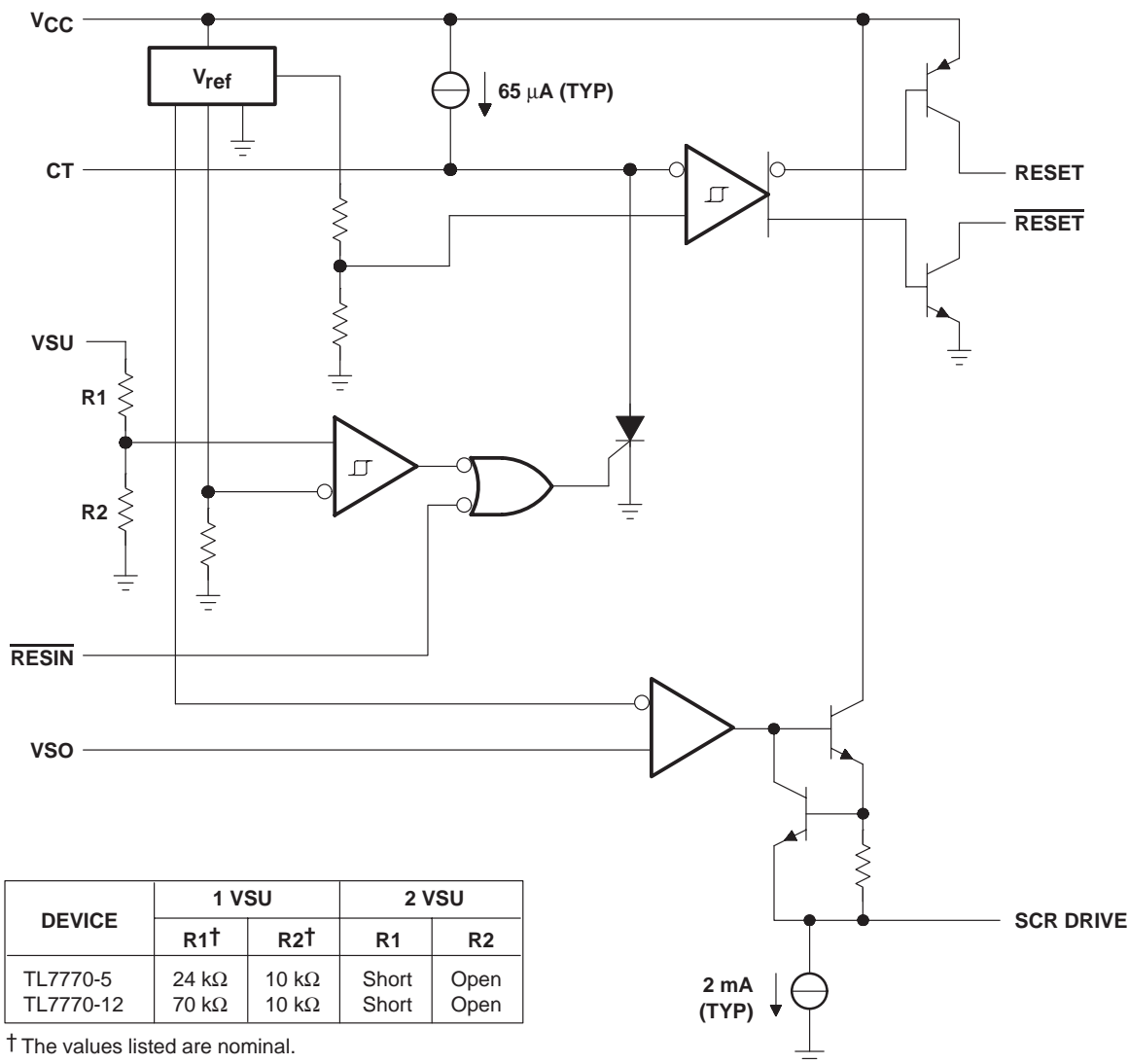
timing requirements
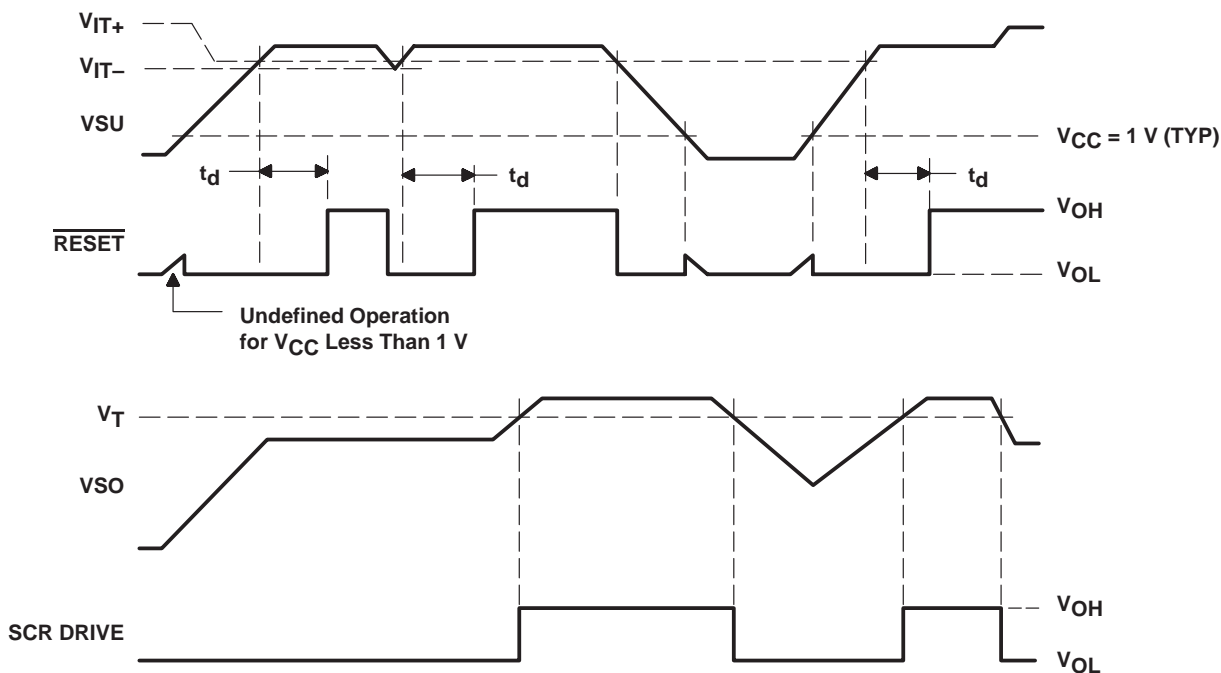
absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1) .... 20 V

Input voltage range, V_I: 1VSU, 2VSU, 1VSO, and 2VSO (see Note 1) .... −0.3 V to 18 V

Low-level output current (1$\overline{RESET}$ and 2$\overline{RESET}$), I_{OL} .... 20 mA

High-level output current (1RESET and 2RESET), I_{OH} .... −20 mA

Package thermal impedance, θ_{JA} (see Notes 2 and 3): DW package .... 57°C/W

N package .... 88°C/W

Lead temperature 1,6 mm (1/16 in) from case for 10 seconds: DW or N package .... 260°C

Storage temperature range, T_{stg} .... −65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values are with respect to the network ground terminal.
2. Maximum power dissipation is a function of T_J(max), θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can impact reliability.
3. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions

		MIN	MAX	UNIT
Supply voltage, V_{CC}		3.5	18	V
Input voltage range, V_I (see Note 4)	1VSU, 2VSU, 2VSO, 1VSO	0	18	V
Output voltage, V_O (1CT, 2CT)			5	V
High-level input voltage range, V_{IH} (1$\overline{RESIN}$, 2$\overline{RESIN}$)		2	18	V
Low-level input voltage range, V_{IL} (1$\overline{RESIN}$, 2$\overline{RESIN}$)		0	0.8	V
Output sink current, I_O (1CT, 2CT)			50	µA
High-level output current, I_{OH} (1RESET, 2RESET)			−16	mA
Low-level output current, I_{OL} (1$\overline{RESET}$, 2$\overline{RESET}$)			16	mA
Continuous output current, I_O (1SCR DRIVE, 2SCR DRIVE)			25	mA
Timing capacitor, C_T			10	µF
Operating free-air temperature, T_A	TL7770C series	0	70	°C
	TL7770I series	−40	85	°C

NOTE 4:   The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for logic voltage levels only.

electrical characteristics over recommended operating conditions (unless otherwise noted)

supply supervisor section

PARAMETER			TEST CONDITIONS[†]	TL7770-5C TL7770-12C TL7770-5I			UNIT
				MIN	TYP[‡]	MAX	
V_{OH}	High-level output voltage	RESET	$I_{OH} = -15$ mA	$V_{CC}-1.5$			V
		SCR DRIVE	$I_{OH} = -20$ mA	$V_{CC}-1.5$			
V_{OL}	Low-level output voltage	$\overline{RESET}$	$I_{OL} = 15$ mA			0.4	V
V_{IT-}	Undervoltage input threshold at VSU (negative-going)	TL7770-5 (5-V sense, 1VSU)	T_A = MIN to MAX	4.46		4.64	V
		TL7770-12 (12-V sense, 1VSU)		10.68		11.12	
		TL7770-5, TL7770-12 (programmable sense, 2VSU)		1.47		1.53	
V_{hys}	Hysteresis at VSU $(V_{IT+} - V_{IT-})$	TL7770-5 (5-V sense, 1VSU)	T_A = MIN to MAX		15		mV
		TL7770-12 (12-V sense, 1VSU)			36		
		TL7770-5, TL7770-12 (programmable sense, 2VSU)			5		
V_T	Overvoltage threshold at VSO	TL7770-5, TL7770-12 (VSO)	T_A = MIN to MAX	2.48		2.68	V
I_I	Input current	$\overline{RESIN}$	$V_I = 5.5$ V or 0.4 V			−10	µA
		VSO	$V_I = 2.4$ V		0.5	2	
I_{OH}	High-level output current	$\overline{RESET}$	$V_O = 18$ V			50	µA
I_{OL}	Low-level output current	RESET	$V_O = 0$			−50	µA
I_{OH}	Peak output current	SCR DRIVE	Duration = 1 ms	250			mA

† For conditions shown as MIN or MAX, use the appropriate value specified in the recommended operating conditions.
‡ Typical values are at $V_{CC} = 5$ V, $T_A = 25°C$.

total device

PARAMETER		TEST CONDITIONS[†]		TL7770-5C TL7770-12C TL7770-5I			UNIT
				MIN	TYP[‡]	MAX	
V_{res}[§]	Power-up reset voltage	V_{CC} = VSU			0.8	1	V
I_{CC}	Supply current	1VSU = 18 V, 2VSU = 2 V, 1$\overline{RESIN}$ and 2$\overline{RESIN}$ at V_{CC}, 1VSO and 2VSO at 0 V	$T_A = 25°C$			5	mA
			T_A = MIN to MAX			6.5	

† For conditions shown as MIN or MAX, use the appropriate value specified in the recommended operating conditions.
‡ Typical values are at $V_{CC} = 5$ V, $T_A = 25°C$.
§ This is the lowest voltage at which $\overline{RESET}$ becomes active.

electrical characteristics over recommended operating conditions (unless otherwise noted)

supply supervisor section

PARAMETER		TEST CONDITIONS	TL7770-5Y TL7770-12Y			UNIT
			MIN	TYP†	MAX	
V_{IT-} Undervoltage input threshold at VSU (negative-going)	TL7770-5 (5-V sense, 1VSU)	T_A = MIN to MAX	4.46		4.64	V
	TL7770-12 (12-V sense, 1VSU)		10.68		11.12	
	TL7770-5, TL7770-12 (programmable sense, 2VSU)		1.47		1.53	
V_{hys} Hysteresis at VSU (V_{IT+} − V_{IT-})	TL7770-5 (5-V sense, 1VSU)	T_A = MIN to MAX		15		mV
	TL7770-12 (12-V sense, 1VSU)			36		
	TL7770-5, TL7770-12 (programmable sense, 2VSU)			5		
V_T Overvoltage threshold at VSO	TL7770-5, TL7770-12 (VSO)	T_A = MIN to MAX	2.48		2.68	V
I_I Input current	VSO	V_I = 2.4 V		0.5		µA

† Typical values are at V_{CC} = 5 V, T_A = 25°C.

total device

PARAMETER		TEST CONDITIONS		TL7770-5Y TL7770-12Y			UNIT
				MIN	TYP†	MAX	
V_{res}‡	Power-up reset voltage	V_{CC} = VSU,	V_{OL} = 0.4 V, I_{OL} = 1 mA		0.8		V
I_{CC}	Supply current	1VSU = 18 V, 2VSU = 2 V, 1RESIN and 2RESIN at V_{CC}, 1VSO and 2VSO at 0 V	T_A = 25°C			5	mA

† Typical values are at V_{CC} = 5 V, T_A = 25°C.
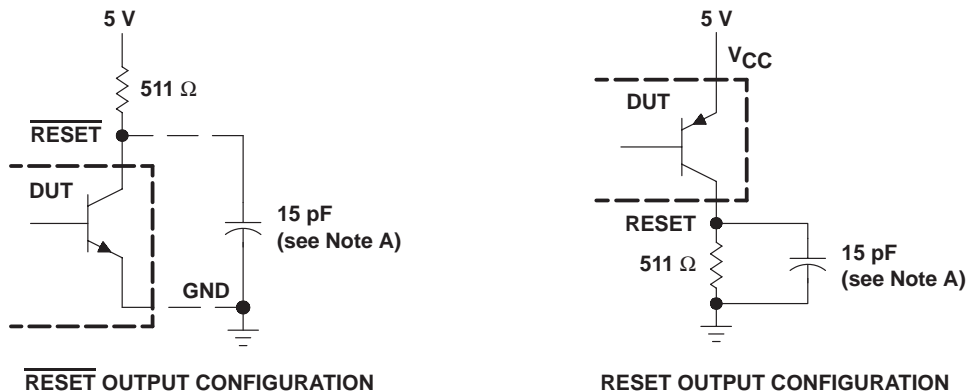‡ This is the lowest voltage at which RESET becomes active.

switching characteristics, V_{CC} = 5 V, C_T open, T_A = 25°C

PARAMETER		FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low-to-high-level output	RESIN	RESET	See Figures 1 and 3		270	500	ns
t_{PHL}	Propagation delay time, high-to-low-level output	RESIN	RESET			270	500	ns
t_r	Rise time		RESET				75	ns
t_f	Fall time					150		
t_r	Rise time		RESET				75	ns
t_f	Fall time						50	
$t_{w(min)}$	Minimum effective pulse duration	RESIN		See Figure 2a		150		ns
		VSU		See Figure 2b		100		

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INSTRUMENTS

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PARAMETER MEASUREMENT INFORMATION

$\overline{\text{RESET}}$ OUTPUT CONFIGURATION

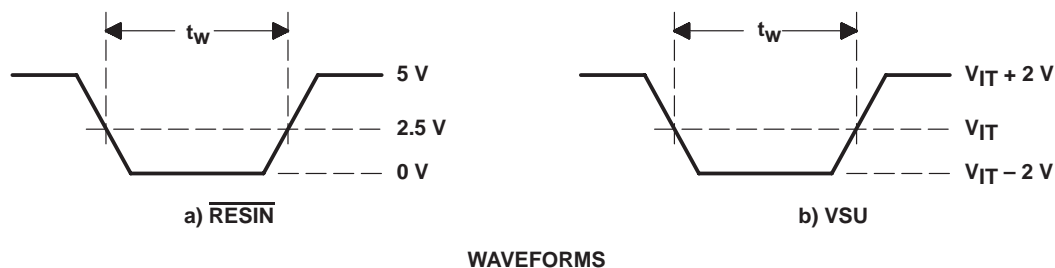RESET OUTPUT CONFIGURATION

NOTE A: This includes jig and probe capacitance.

Figure 1. $\overline{\text{RESET}}$ and RESET Output Configurations

a) $\overline{\text{RESIN}}$

b) VSU

WAVEFORMS

Figure 2. Input Pulse Definition
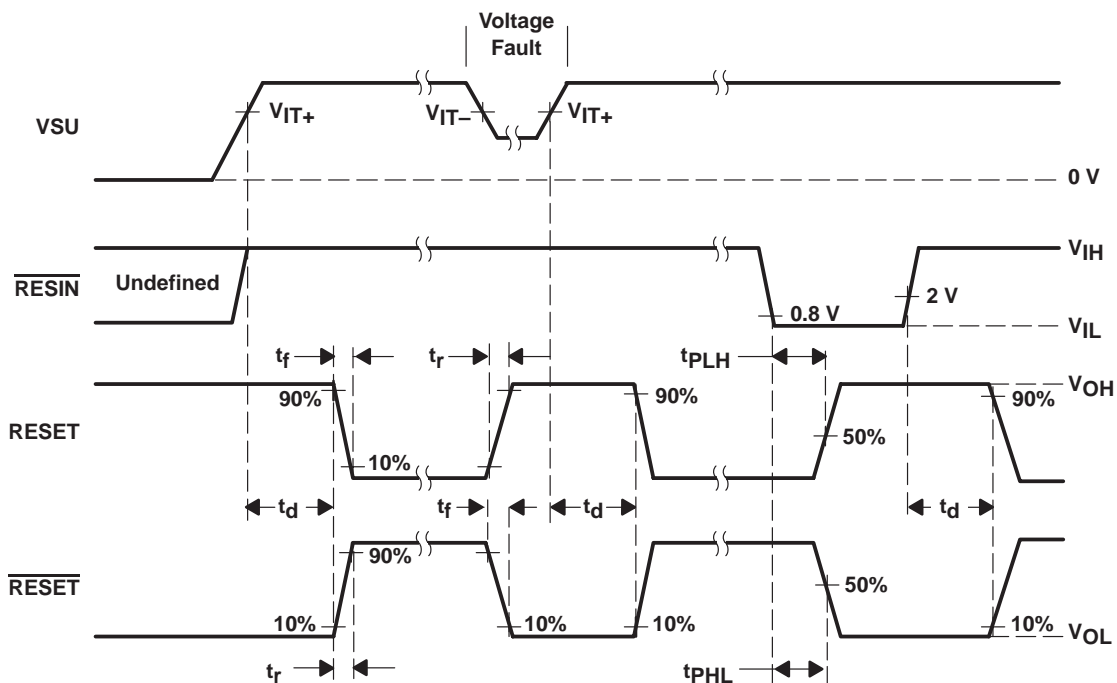
Figure 3. Voltage Waveforms

APPLICATION INFORMATION
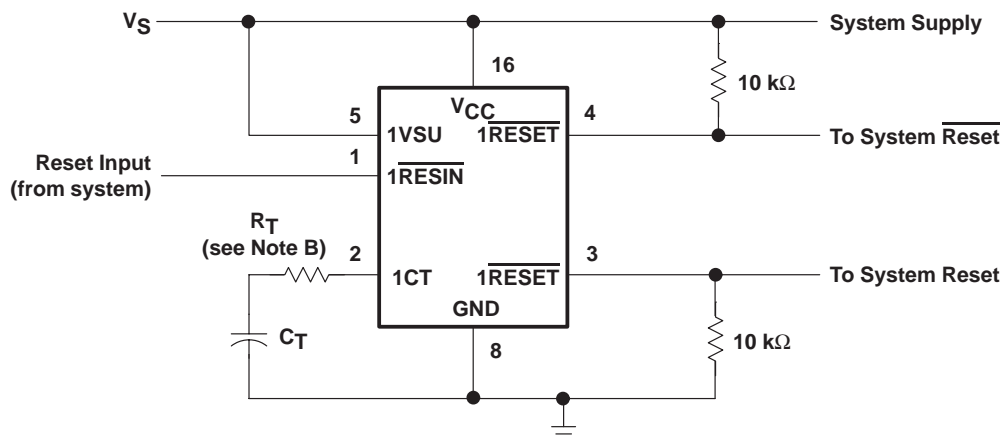
NOTE B: When V_{CC} and 1VSU are connected to the same point, it is recommended that series resistance (R_T) be added between the time-delay programming capacitor (C_T) and the voltage-supervisor device terminal (1CT). The suggested R_T value is given by:

$$R_T > \frac{V_I - V_{IT-}}{1 \times 10^{-3}}, \text{ where } V_I = \left(\text{the lesser of 7.1 V or } V_S\right)$$

When this series resistor is used, the t_d calculation is as follows:

$$t_d = \frac{1.3 - \left[\left((6.5E - 5) \times 10^{-5}\right) \times R_T\right]}{6.5 \times 10^{-5}} \times C_T$$

Figure 4. System Reset Controller With Undervoltage Sensing

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TL7770-12CDWR	ACTIVE	SOIC	DW	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	7770-12C	Samples
TL7770-5CDW	ACTIVE	SOIC	DW	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	TL7770-5C	Samples
TL7770-5CDWR	ACTIVE	SOIC	DW	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	TL7770-5C	Samples
TL7770-5CN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	TL7770-5CN	Samples
TL7770-5IDW	ACTIVE	SOIC	DW	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL7770-5I	Samples
TL7770-5IDWG4	ACTIVE	SOIC	DW	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL7770-5I	Samples
TL7770-5IDWR	ACTIVE	SOIC	DW	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL7770-5I	Samples
TL7770-5IDWRE4	ACTIVE	SOIC	DW	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	TL7770-5I	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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![Texas Instruments logo]

PACKAGE MATERIALS INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL7770-12CDWR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1
TL7770-5CDWR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1
TL7770-5IDWR	SOIC	DW	16	2000	330.0	16.4	10.75	10.7	2.7	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL7770-12CDWR	SOIC	DW	16	2000	350.0	350.0	43.0
TL7770-5CDWR	SOIC	DW	16	2000	350.0	350.0	43.0
TL7770-5IDWR	SOIC	DW	16	2000	350.0	350.0	43.0

DW 16

7.5 x 10.3, 1.27 mm pitch

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4224780/A

10.63 / 9.97 TYP

PIN 1 ID AREA

A

1

16

14X 1.27

2X 8.89

10.5 / 10.1 NOTE 3

8

9

B

7.6 / 7.4 NOTE 4

16X 0.51 / 0.31

⊕ | 0.25Ⓜ | C | A | B

C

SEATING PLANE

◠ | 0.1 | C

2.65 MAX

0.33 / 0.10 TYP

SEE DETAIL A

0.25

GAGE PLANE

0° - 8°

1.27 / 0.40

(1.4)

0.3 / 0.1

DETAIL A
TYPICAL

4220721/A   07/2016

NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.
5. Reference JEDEC registration MS-013.

16X (2)

SYMM
₡

SEE
DETAILS

1

16

16X (0.6)

SYMM
₡

14X (1.27)

8

9

R0.05 TYP

(9.3)

LAND PATTERN EXAMPLE
SCALE:7X

METAL

SOLDER MASK
OPENING

SOLDER MASK
OPENING

METAL

0.07 MAX
ALL AROUND

0.07 MIN
ALL AROUND

NON SOLDER MASK
DEFINED

SOLDER MASK
DEFINED

SOLDER MASK DETAILS

4220721/A   07/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

16X (2)

1

16X (0.6)

14X (1.27)

8

R0.05 TYP

16

SYMM

SYMM

9

(9.3)

SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:7X

4220721/A   07/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

N (R−PDIP−T**)

16 PINS SHOWN

PLASTIC DUAL−IN−LINE PACKAGE

PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS−001 VARIATION	AA	BB	AC	AD

A

16   9

0.260 (6,60)
0.240 (6,10)

1   8

0.070 (1,78)
0.045 (1,14)

0.045 (1,14)
0.030 (0,76)

0.020 (0,51) MIN

0.200 (5,08) MAX

Seating Plane

0.125 (3,18) MIN

0.100 (2,54)

0.021 (0,53)
0.015 (0,38)

⊕ 0.010 (0,25) M

14/18 Pin Only
20 Pin vendor option

0.325 (8,26)
0.300 (7,62)

0.015 (0,38)

Gauge Plane

0.010 (0,25) NOM

0.430 (10,92) MAX

4040049/E 12/2002

NOTES: A.   All linear dimensions are in inches (millimeters).
         B.   This drawing is subject to change without notice.
         C.   Falls within JEDEC MS−001, except 18 and 20 pin minimum body length (Dim A).
         D.   The 20 pin end lead shoulder width is a vendor option, either half or full width.